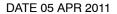


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND
- 0.20 mm FROM THE TERMINAL TIPS. 4. PACKAGE DIMENSIONS EXCLUSIVE OF

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.70	0.80	
A1	0.00	0.05	
A3	0.20 REF		
b	0.20	0.30	
D	1.00 BSC		
Е	1.20 BSC		
е	0.50 BSC		
L	0.35	0.45	

MARKING DIAGRAM*

X = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part

Pb-Free indicator, "G" or microdot " .", may or may not be present.

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DESCRIPTION:	WDFN4, 1.0X1.2, 0.5P		PAGE 1 OF 1	
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